

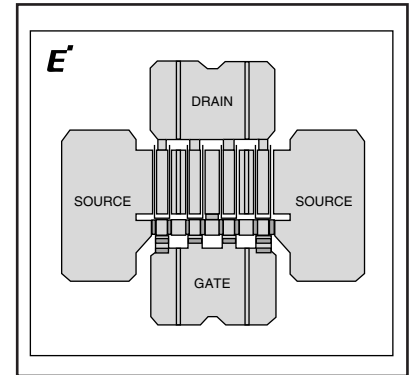
FEATURES

- Medium Power Output: $P_{1dB}=24.5dBm(Typ.)@8.0GHz$
- High Power Gain: $G_{1dB}=10dB(Typ.)@8.0GHz$
- Proven Reliability

DESCRIPTION

The FSX027X is a general purpose GaAs FET designed for medium power applications up to 12GHz. These devices have a wide dynamic range and are suitable for use in medium power, wide band, linear drive amplifiers or oscillators.

Eudyna stringent Quality Assurance Program assures the highest reliability and consistent performance.



ABSOLUTE MAXIMUM RATINGS (Ambient Temperature $T_a = 25^\circ C$)

Parameter	Symbol	Condition	Rating	Unit
Drain-Source Voltage	V_{DS}		12	V
Gate-Source Voltage	V_{GS}		-5	V
Total Power Dissipation	P_T	$T_C = 25^\circ C$	1.5	W
Storage Temperature	T_{STG}		-65 to 175	$^\circ C$
Channel Temperature	T_{CH}		175	$^\circ C$

Eudyna recommends the following conditions for the reliable operation of GaAs FETs:

1. The drain-source operating voltage (V_{DS}) should not exceed 8 volts.
2. The forward and reverse gate currents should not exceed 1.4 and -0.2 mA respectively with gate resistance of 1000 Ω .
3. The operating channel temperature (T_{ch}) should not exceed 145 $^\circ C$.

ELECTRICAL CHARACTERISTICS (Ambient Temperature $T_a=25^\circ C$)

Item	Symbol	Test Conditions	Limit			Unit	
			Min.	Typ.	Max.		
Saturated Drain Current	I_{DSS}	$V_{DS} = 3V, V_{GS} = 0V$	70	110	150	mA	
Transconductance	g_m	$V_{DS} = 3V, I_{DS} = 54mA$	-	100	-	mS	
Pinch-off Voltage	V_p	$V_{DS} = 3V, I_{DS} = 5.4mA$	-0.7	-1.2	-1.7	V	
Gate Source Breakdown Voltage	V_{GSO}	$I_{GS} = -5.4\mu A$	-5.0	-	-	V	
Noise Figure	NF	$V_{DS} = 3V, I_{DS} = 30mA$ $f = 8GHz$	-	2.5	-	dB	
Associated Gain	G_{as}		-	9.5	-	dB	
Output Power at 1 dB G.C.P.	P_{1dB}	$V_{DS} = 8V,$ $I_{DS} = 0.7I_{DSS}$	$f = 4GHz$	-	24.5	-	dBm
			$f = 8GHz$	23.5	24.5	-	dBm
			$f = 12GHz$	-	23.5	-	dBm
Power Gain at 1 dB G.C.P.	G_{1dB}	$V_{DS} = 8V,$ $I_{DS} = 0.7I_{DSS}$	$f = 4GHz$	-	14.0	-	dB
			$f = 8GHz$	9.0	10.0	-	dB
			$f = 12GHz$	-	6.5	-	dB
Thermal Resistance	R_{th}	Channel to Case	-	70	100	$^\circ C/W$	

Note: RF parameter sample size 10pcs. criteria (accept/reject)=(2/3)

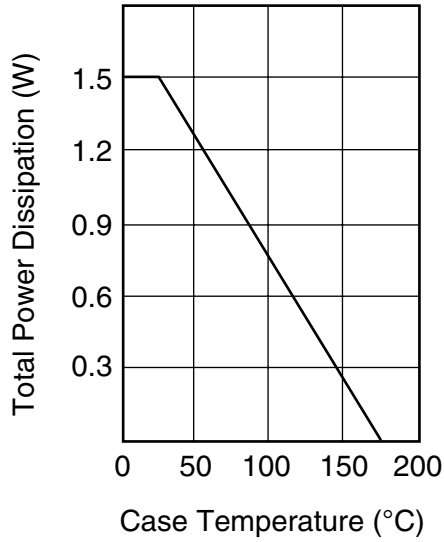
G.C.P.: Gain Compression Point

The chip must be enclosed in a hermetically sealed environment for optimum performance and reliability.

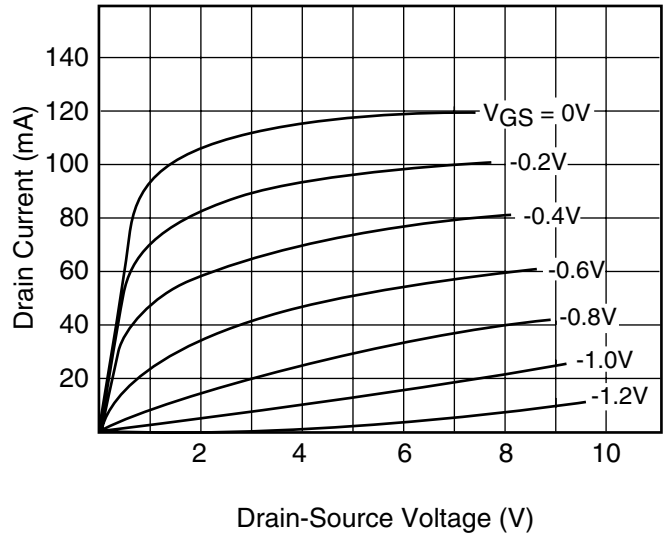
FSX027X

GaAs FET & HEMT Chips

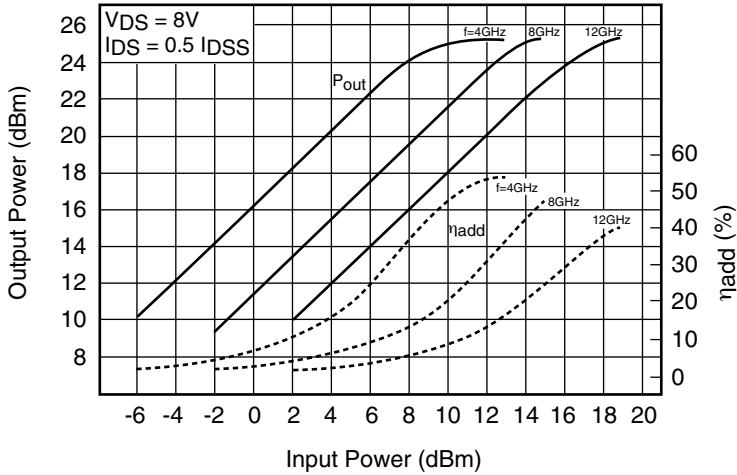
POWER DERATING CURVE



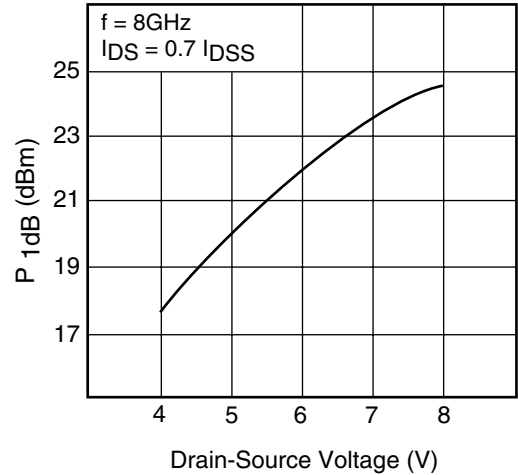
DRAIN CURRENT vs. DRAIN-SOURCE VOLTAGE



OUTPUT POWER vs. INPUT POWER



P 1dB vs. VDS



S-PARAMETERS

$V_{DS} = 8V, I_{DS} = 75mA$

FREQUENCY (MHZ)	S11		S21		S12		S22	
	MAG	ANG	MAG	ANG	MAG	ANG	MAG	ANG
1000	.981	-41.2	7.117	153.2	.023	67.6	.633	-14.9
2000	.946	-75.2	6.065	130.8	.040	50.3	.588	-26.6
3000	.913	-100.3	5.015	113.3	.050	37.4	.548	-35.2
4000	.882	-118.9	4.168	99.4	.055	28.8	.523	-42.1
5000	.877	-132.7	3.520	87.9	.058	22.2	.506	-48.4
6000	.867	-143.6	3.026	77.9	.060	17.3	.498	-54.7
7000	.860	-152.5	2.644	69.0	.062	13.6	.499	-60.9
8000	.854	-159.9	2.336	60.9	.063	10.2	.504	-67.1
9000	.849	-166.3	2.089	53.1	.064	7.0	.515	-73.4
10000	.845	-172.0	1.887	45.8	.065	4.4	.524	-79.0
11000	.841	-177.2	1.716	36.7	.065	2.1	.539	-84.7
12000	.837	178.3	1.569	32.0	.065	0.0	.550	-90.3
13000	.834	174.1	1.441	25.4	.066	-1.0	.561	-95.7
14000	.829	169.8	1.332	18.9	.067	-3.5	.574	-101.2
15000	.826	166.1	1.238	12.6	.067	-5.4	.589	-106.8
16000	.824	162.7	1.155	6.6	.068	-6.1	.603	-112.5
17000	.817	159.3	1.074	.4	.069	-9.1	.623	-118.0
18000	.813	155.9	1.001	-5.5	.068	-10.4	.642	-123.1
19000	.814	152.8	.543	-11.3	.069	-11.2	.657	-127.9
20000	.811	150.1	.888	-16.9	.069	-13.4	.672	-132.7

NOTE:* The data includes bonding wires.

n: number of wires

Gate n=1 (0.2mm length, 25µm Dia Au wire)

Drain n=1 (0.2mm length, 25µm Dia Au wire)

Source n=4 (0.2mm length, 25µm Dia Au wire)

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GaAs FET & HEMT Chips

